

LINEAR TECHNOLOGY MATERIALS DECLARATION

LTC2945IUD-1#TRPBF

(Engineering Calculation)

QFN 3mm X 3mm Exp. Pad

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TOTAL MASS (g): 0.023344

COMPONENT MATERIAL	VENDOR/INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL Pkg.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.001099	1000000	47878.5609375		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.008752	975000	374918.15625		
		Iron (Fe)	7439-89-6	0.000215	24000	9210.16894531		
		Phosphorus (P)	7723-14-0	0.000003	300	128.514007568		
		Zinc (Zn)	7440-66-6	0.000006	700	257.028015137		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-98-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead Frame Total:				0.008976	1000000	384513.875
		Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0
Exter. Plating Sn	7440-31-5			0.000413	1000000	17681.8652344		
External Plating Total:						0.000413	1000000	17681.8652344
Inter. Plating Ni	7440-02-0			0.000000	0	0		
Inter. Plating Ag	7440-22-4			0.000203	1000000	8696.11328125		
Internal Plating Total:						0.000203	1000000	8696.11328125
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000004	750000	25874.1503906		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000201	250000	8610.4375		
		Die Attach Total:				0.000405	1000000	34484.5896438
		Encapsulation	MULTIAROMATIC RESIN BOND FREE	Resin (EP)	0.011534	130000	65713.4921875	
Bromine (Br)	40093-93-8			0.000000	0	0		
Silica (SiO2)	60676-86-0			0.010148	860000	434720		
Antimony Trioxide (Sb2O3)	1309-64-4			0.000000	0	0		
Metal Hydroxide				0.000000	0	0		
Carbon Black (C)	1333-86-4			0.000118	10000	5054.88427734		
Encapsulation Total:						0.011800	1000000	505488.40625
Bond Wire Estimated	AFW/TANAKA/Kn	Gold (Au)	7440-57-5	0.000048	1000000	2056.22412109		

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